



## Intelligent Antennas

Guest Editor:

**Prof. Pedram Mousavi**

Department of Mechanical  
Engineering, University of  
Alberta, Edmonton, AB T6G 1H9,  
Canada

Deadline for manuscript  
submissions:

**closed (31 May 2019)**

### Message from the Guest Editor

The unprecedented emergence of new wireless applications in recent years pervades all aspect of our lives. To handle the demand, the telecommunication industry will develop the 5<sup>th</sup> generation of networks. These devices will be used in many applications such as telecommunication networks, health care, sensing, imaging, oil and gas, military, transportation, wearable devices, smart appliances and smart buildings. Hosting all these applications and accommodating future applications in a single platform will require reconfigurable, flexible, multi-band, energy smart (such as harvesting) and intelligent antennas. This Special Issue will present scholarly papers that address critical issues in theory, design, manufacturing (use of new materials and manufacturing process such as 3D printing) and measurements (such as fast near-field measurements) of intelligent antennas.

More information, please click [here](#).





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## Editor-in-Chief

**Prof. Dr. Flavio Canavero**

Department of Electronics and  
Telecommunications,  
Politecnico di Torino, 10129  
Torino, Italy

## Message from the Editor-in-Chief

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Electronics Editorial Office  
MDPI, Grosspeteranlage 5  
4052 Basel, Switzerland

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